

PRODUCT RELIABILITY REPORT FOR

DS28E10, Rev A3

Maxim Integrated Products

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Conclusion:

The following qualification successfully meets the quality and reliability standards required of all Maxim products:

In addition, Maxim's continuous reliability monitor program ensures that all outgoing product will continue to meet Maxim's quality and reliability standards. The current status of the reliability monitor program can be viewed at http://www.maxim-ic.com/TechSupport /dsreliability.html.

Device Description:

A description of this device can be found in the product data sheet. You can find the product data sheet at http://dbserv.maxim-ic.com/l_datasheet3.cfm.

Reliability Derating:

The Arrhenius model will be used to determine the acceleration factor for failure mechanisms that are temperature accelerated.

```
AfT = exp((Ea/k)*(1/Tu - 1/Ts)) = tu/ts
AfT = Acceleration factor due to Temperature
tu = Time at use temperature (e.g. 55°C)
ts = Time at stress temperature (e.g. 125°C)
k = Boltzmann's Constant (8.617 x 10-5 eV/°K)
Tu = Temperature at Use (°K)
Ts = Temperature at Stress (°K)
Ea = Activation Energy (e.g. 0.7 ev)
```

The activation energy of the failure mechanism is derived from either internal studies or industry accepted standards, or activation energy of 0.7ev will be used whenever actual failure mechanisms or their activation energies are unknown. All deratings will be done from the stress ambient temperature to the use ambient temperature.

An exponential model will be used to determine the acceleration factor for failure mechanisms, which are voltage accelerated.

```
AfV = exp(B*(Vs - Vu))

AfV = Acceleration factor due to Voltage

Vs = Stress Voltage (e.g. 7.0 volts)

Vu = Maximum Operating Voltage (e.g. 5.5 volts)

B = Constant related to failure mechanism type (e.g. 1.0, 2.4, 2.7, etc.)
```

The Constant, B, related to the failure mechanism is derived from either internal studies or industry accepted standards, or a B of 1.0 will be used whenever actual failure mechanisms or their B are unknown. All deratings will be done from the stress voltage to the maximum operating voltage. Failure rate data from the operating life test is reported using a Chi-Squared statistical model at the 60% or 90% confidence level (Cf).

The failure rate, Fr, is related to the acceleration during life test by:

```
Fr = X/(ts * AfV * AfT * N * 2)
X = Chi-Sq statistical upper limit
N = Life test sample size
```

Failure Rates are reported in FITs (Failures in Time) or MTTF (Mean Time To Failure). The FIT rate is related to MTTF by:

MTTF = 1/Fr

NOTE: MTTF is frequently used interchangeably with MTBF.

The calculated failure rate for this device/process is:

FAILURE RATE: MTTF (YRS): 284247 FITS: 2.5

DEVICE HOURS: 367923024 FAILS: 0

Only data from Operating Life or similar stresses are used for this calculation.

The parameters used to calculate this failure rate are as follows:

Cf: 60% Ea: 0.7 B: 0 Tu: 25 °C Vu: 3.6 Volts

The reliability data follows. At the start of this data is the device information. The next section is the detailed reliability data for each stress. The reliability data section includes the latest data available and may contain some generic data. **Bold** Product Number denotes specific product data.

Device Information:

Process: Maxim X3 Fab S18C 3V & 5V CMOS, 4 metals

Passivation: SiN / SiO2
Die Size: 35 x 52
Number of Transistors: 80402

Interconnect: Aluminum / 0.5% Copper

Gate Oxide Thickness: 140Å

ESD HBM									
DESCRIPTION	DATE CODE/PRODUCT/LOT		CONDITION	READPOIN		QTY	FAILS	FA#	
ESD SENSITIVITY	1018	DS28E10	QH000900A	JESD22-A114 HBM 500 VOLTS	1	PUL'S	3	0	
ESD SENSITIVITY	1018	DS28E10	QH000900A	JESD22-A114 HBM 1000 VOLTS	1	PUL'S	3	0	
ESD SENSITIVITY	1018	DS28E10	QH000900A	JESD22-A114 HBM 2000 VOLTS	1	PUL'S	3	0	
ESD SENSITIVITY	1018	DS28E10	QH000900A	JESD22-A114 HBM 4000 VOLTS	1	PUL'S	3	0	
ESD SENSITIVITY	1018	DS28E10	QH000900A	JESD22-A114 HBM 5000 VOLTS	1	PUL'S	3	0	
ESD SENSITIVITY	1018	DS28E10	QH000900A	JESD22-A114 HBM 6000 VOLTS	1	PUL'S	3	0	
ESD SENSITIVITY	1018	DS28E10	QH000900A	JESD22-A114 HBM 7000 VOLTS	1	PUL'S	3	1	No FA
					Total:			1	

LATCH-UP								
DESCRIPTION	DATE	CODE/PRODUCT	/LOT	CONDITION	READPOIN	QTY	FAILS	FA#
LATCH-UP I	1018	DS28E10	QH000900A	JESD78A, I-TEST 125C		6	0	
LATCH-UP V	1018	DS28E10	QH000900A	JESD78A, V-SUPPLY TEST 125C		6	0	
					Total:		0	

OPERATING LIFE			
DESCRIPTION	DATE CODE/PRODUCT/LOT CONDITION	READPOIN	QTY FAILS FA#
HIGH TEMP OP LIFE	0916 MAX9832ETG+ STHZEQ001 135C, 5.0 VOLTS	1000 HRS	77 0
HIGH TEMP OP LIFE	0922 MAX9832ETG+ STHZE3003 135C, 5.0 VOLTS	1000 HRS	77 0
HIGH TEMP OP LIFE	0922 MAX9832ETG+ STHZEZ005 135C, 5.0 VOLTS	1000 HRS	77 0
HIGH TEMP OP LIFE	1003 MAX17042 QJ000200DA 125C, 5.5 VOLTS	192 HRS	45 0
HIGH TEMP OP LIFE	1018 DS28E10 QH000900A 125C, 3.6 VOLTS	192 HRS	45 0
		Total:	0
FAILURE RATE:	MTTF (YRS): 284247 FITS:	2.5	
	DEVICE HOURS: 367923024 FAILS:	0	